## R46 (Miniature), Class X2, 275 VAC, 110°C



#### **Overview**

The R46 series is constructed of metallized polypropylene film encapsulated with self-extinguishing resin in a box of material that meets the requirements of UL 94 V-0.

### **Applications**

For worldwide use in electromagnetic interference (EMI) suppression in across-the-line applications that require X2 safety classification. Intended for use in situations in which capacitor failure would not result in exposure to electric shock. Not for use in "series with mains" type applications.

#### **Benefits**

Approvals: ENEC, UL, cUL, CQC
X2 CLASS (IEC 60384-14)

Rated voltage: 275 VAC 50/60 Hz
Capacitance range: 0.033 - 10 µF
Lead spacing: 10.0 - 37.5 mm

• Capacitance tolerance: ±20%, ±10%

Climatic category 40/110/56, IEC 60068-1

• Tape & Reel in accordance with IEC 60286-2

· RoHS compliant and lead-free terminations

• Operating temperature range of -40°C to +110°C

• 100% screening factory test at 2,200 VDC/1,500 VAC

Self healing properties



## **Part Number System**

R46	K	I	3470	00	P0	M
Series	Rated Voltage (VAC)	Lead Spacing (mm)	Capacitance Code (pF)	Packaging	Internal Use	Capacitance Tolerance
X2, Metallized Polypropylene	K = 275	F = 10.0 I = 15.0 N = 22.5 R = 27.5 W = 37.5	The last three digits represent significant figures. The first digit specifies number of zeros to be added.	See Ordering Options Table	P0 P1 P2 P3	K = ±10% M = ±20%



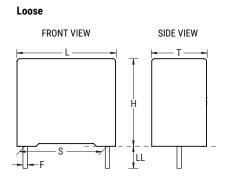
## **Ordering Options Table**

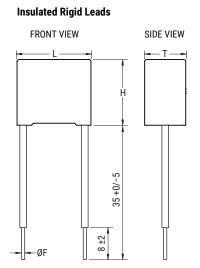
Lead Spacing Nominal (mm)	Type of Leads and Packaging	Lead Length (mm)	Lead and Packaging Code
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4 +2/-0	00
	Ammo Pack	$H_0 = 18.5 \pm 0.5$	DQ
	Other Lead and Packaging Options		
	Tape & Reel (Large Reel)	$H_0 = 18.5 \pm 0.5$	CK
	Bulk (Bag) – Short Leads	2.7 +0.5/-0	JA
10	Bulk (Bag) – Short Leads	3.5 +0.5/-0	JB
15	Bulk (Bag) – Short Leads	4.0 +0.5/-0	JE
22.5	Bulk (Bag) – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Bag) – Long Leads	18 ±1	JM
	Bulk (Bag) – Long Leads	30 +5/-0	40
	Bulk (Bag) – Long Leads	25 +2/-1	50
	Bulk (Bag) – Insulated Rigid Leads	30 +5/-0 (sp 8 ±2)	51
	Bulk (Bag) – Insulated Flexible Leads	150 ±5 (sp 8 ±2)	52
	Standard Lead and Packaging Options		
	Bulk (Bag) – Short Leads	4 +2/-0	00
	Tape & Reel (Large Reel)	H <sub>0</sub> = 18.5 ±0.5	CK <sup>1</sup>
	Other Lead and Packaging Options	,	
	Bulk (Tray) – Short Leads	2.7 +0.5/-0	JA
	Bulk (Tray) – Short Leads	3.5 +0.5/-0	JB
27.5	Bulk (Tray) – Short Leads	4.0 +0.5/-0	JE
	Bulk (Tray) – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Tray) – Long Leads	18 ±1	JM
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50
	Bulk (Bag) – Insulated Rigid Leads	30 +5/-0 (sp 8 ±2)	51
	Bulk (Bag) – Insulated Flexible Leads	150 ±5 (sp 8 ±2)	52
	Standard Lead and Packaging Options		
	Bulk (Tray) – Short Leads	4 +2/-0	00
	Other Lead and Packaging Options		
	Bulk (Tray) – Short Leads	2.7 +0.5/-0	JA
	Bulk (Tray) – Short Leads	3.5 +0.5/-0	JB
37.5	Bulk (Tray) – Short Leads	4.0 +0.5/-0	JE
37.3	Bulk (Tray) – Short Leads	3.2 +0.3/-0.2	JH
	Bulk (Tray) – Long Leads	18 ±1	JM
	Bulk (Tray) – Long Leads	30 +5/-0	40
	Bulk (Tray) – Long Leads	25 +2/-1	50
	Bulk (Bag) – Insulated Rigid Leads	30 +5/-0 (sp 8 ±2)	51
	Bulk (Bag) – Insulated Flexible Leads	150 ±5 (sp 8 ±2)	52

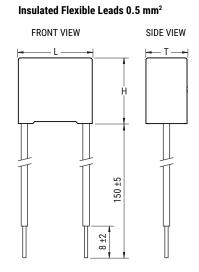
<sup>&</sup>lt;sup>1</sup> Not for all sizes, see "Packaging Quantities" table.



### **Dimensions - Millimeters**







	S	-	T H L		Ĺ		F		
Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance	Nominal	Tolerance
10.0	±0.4	4.0	+0.2/-0.5	9.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05
10.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05
10.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	13.0	+0.2/-0.5	0.6	±0.05
15.0	±0.4	5.0	+0.2/-0.5	11.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	6.0	+0.2/-0.5	12.0	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	6.0	+0.2/-0.5	17.5	+0.1/-0.5	18.0	+0.3/-0.5	0.6	±0.05
15.0	±0.4	7.5	+0.2/-0.5	13.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	7.5	+0.2/-0.5	18.5	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	8.5	+0.2/-0.5	14.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	9.0	+0.2/-0.5	12.5	+0.1/-0.5	18.0	+0.5/-0.5	0.6	±0.05
15.0	±0.4	10.0	+0.2/-0.5	16.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
15.0	±0.4	11.0	+0.2/-0.5	19.0	+0.1/-0.5	18.0	+0.5/-0.5	0.8	±0.05
22.5	±0.4	6.0	+0.2/-0.5	15.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	7.0	+0.2/-0.5	16.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	8.5	+0.2/-0.5	17.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	10.0	+0.2/-0.5	18.5	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	11.0	+0.2/-0.5	20.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
22.5	±0.4	13.0	+0.2/-0.5	22.0	+0.1/-0.5	26.5	+0.3/-0.5	0.8	±0.05
27.5	±0.4	9.0	+0.2/-0.7	17.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	11.0	+0.2/-0.7	20.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	13.0	+0.2/-0.7	22.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	14.0	+0.2/-0.7	28.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	18.0	+0.2/-0.7	33.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
27.5	±0.4	22.0	+0.2/-0.7	37.0	+0.1/-0.7	32.0	+0.3/-0.7	0.8	±0.05
37.5	±0.4	11.0	+0.3/-0.7	22.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	13.0	+0.3/-0.7	24.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	16.0	+0.3/-0.7	28.5	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	19.0	+0.3/-0.7	32.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
37.5	±0.4	20.0	+0.3/-0.7	40.0	+0.1/-0.7	41.5	+0.3/-0.7	1.0	±0.05
		Note: Se	e Ordering O	ptions Tabl	e for lead ler	ngth (LL/H₀)	options.		

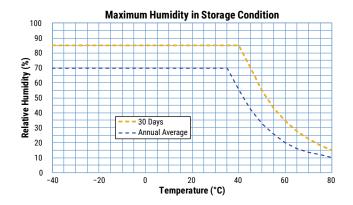


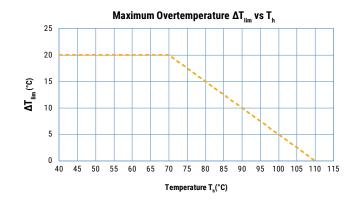
## **Performance Characteristics**

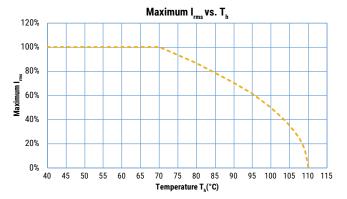
Dielectric	Polypropylene film									
Plates	Metal layer deposited by	evaporation under vacuum								
Winding	Non-inductive type									
Leads	Tinned wire									
Protection	Plastic case, thermosetting	g resin filled. Box material is so	olvent resistant and flame reta	ardant according to UL94.						
Related Documents	IEC 60384-14, EN 60384-	14								
Rated Voltage V <sub>R</sub>	275 VAC (50/60 Hz)									
Recommended DC Voltage	≤ 560 VDC									
Capacitance Range	0.033 - 10 μF									
Capacitance Values	E6 series (IEC 60063) me	asured at 1 kHz and +20 ±1	°C							
Capacitance Tolerance	±10%, ±20%									
Temperature Range	-40°C to +110°C									
Climatic Category	40/110/56 IEC 60068-1									
	Storage time: ≤ 24 month	s from the date marked on	the label package							
	Average relative humidity	per year ≤ 70%								
Storage Conditions	RH ≤ 85% for 30 days ran	domly distributed througho	ut the year							
	Dew is absent									
	Temperature: -40 to 80°0	C (see "Maximum Humidity	n Storage Conditions" grap	h below)						
Approvals	ENEC, UL, cUL, CQC									
Dissipation Factor (tanδ)	≤ 0.1% (0.06%*) at 1 kHz ,	+25°C ±5°C (* typical value	)							
Test Voltage Between Terminals	The 100% screening factory test is carried out at 2,200 VDC/1,500 VAC.  The voltage level is selected to meet the requirements in applicable equipment standards.  All electrical characteristics are checked after the test. This test cannot be repeated, as there is a risk of damaging the capacitor. KEMET is not liable in such cases for any failures.									
		Measured at +25°C ±5°C,	according to IEC 60384-2							
1 10 5		Minimum Values E	etween Terminals							
Insulation Resistance	Voltage Charge	Voltage Charge Time	C ≤ 0.33 µF	C > 0.33 μF						
	100 VDC	1 minute	$\geq 1 \cdot 10^{5} M\Omega$ ( $\geq 5 \cdot 10^{5} M\Omega$ )*	≥ 30,000 MΩ • μF ( ≥ 150,000 MΩ • μF )*						



### **Performance Characteristics cont.**

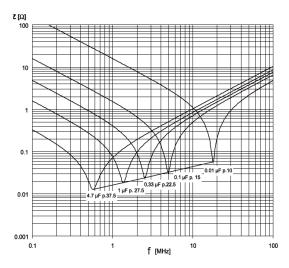






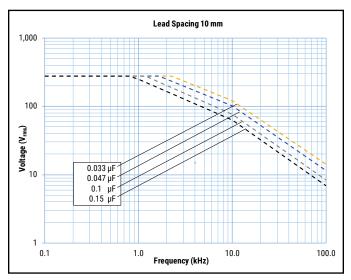
 $T_h$  is the maximum ambient temperature surrounding the capacitor or hottest contact point (e.g. tracks), whichever is higher, in the worst operation conditions in  $^{\circ}$ C.

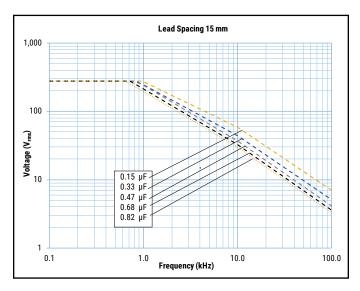
## **Impedance Graph**

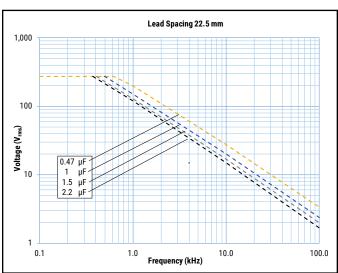


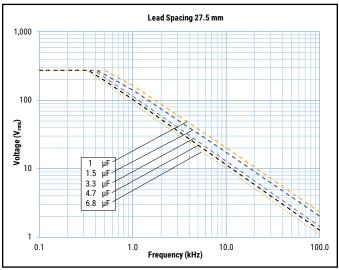


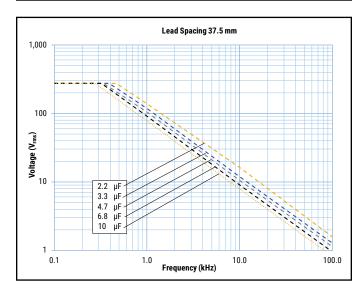
# Maximum Voltage ( $V_{rms}$ ) Versus Frequency (Sinusoidal Waveform/Th $\leq 70$ °C)





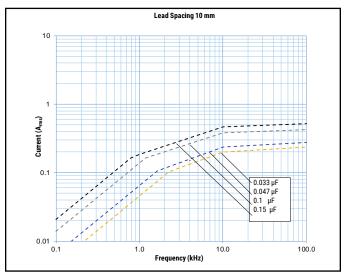


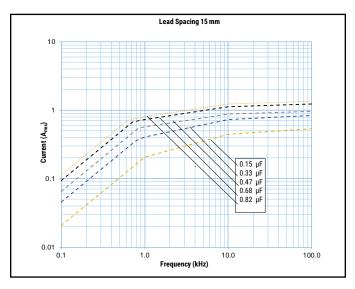


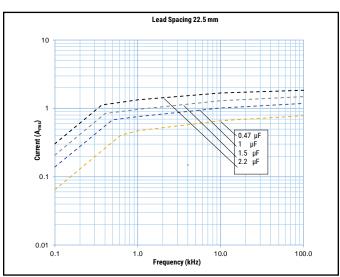


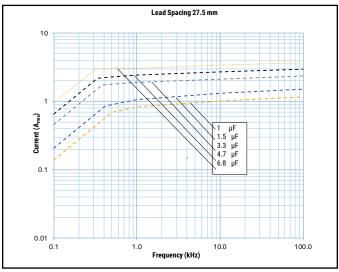


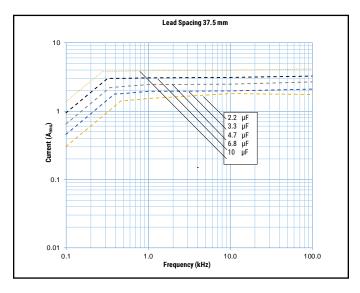
# Maximum Current ( $I_{rms}$ ) Versus Frequency (Sinusoidal Waveform/Th $\leq 70^{\circ}$ C)













### **Environmental Test Data**

Test	IEC Publication	Procedure
Endurance	EN/IEC 60384-14	1.25 x V <sub>R</sub> VAC 50 Hz, once every hour increase to 1,000 VAC for 0.1 second, 1,000 hours at upper rated temperature
Vibration	IEC 60068-2-6 Test Fc	3 directions at 2 hours each 10 – 55 Hz at 0.75 mm or 98 m/s²
Bump	IEC 60068-2-29 Test Eb	1,000 bumps at 390 m/s <sup>2</sup>
Change of Temperature	IEC 60068-2-14 Test Na	Upper and lower rated temperature 5 cycles
Active Flammability	IEC 60384-14	V <sub>R</sub> + 20 surge pulses at 2.5 kV (pulse every 5 seconds)
Passive Flammability	IEC 60384-14	IEC 60384-1, IEC 60695-11-5 Needle flame test
Damp Heat Steady State	IEC 60068-2-78 Test Cab	+40°C and 93% RH, 56 days

## **Approvals**

Certification Body	Mark	Specification	File Number
IMQ S-p.A.		EN/IEC 60384-14	V4413
UL	c <b>SN</b> °us	UL 60384-14 and CAN/CSA E60384-14 (310 VAC)	E97797
cqc	cec	GB/T 14472 IEC 60384-14	CQC08001026549 CQC11001060118 CQC13001087757 CQC13001101266

## **Environmental Compliance**

All KEMET EMI capacitors are RoHS compliant.





**Table 1 - Ratings & Part Number Reference** 

Capacitance	Dime	ensions ir	n mm	Lead Spacing	dV/dt	KEMET	Legacy Part
Value (µF)	T	Н	L	(S)	(V/µs)	Part Number	Number
0.033	4.0	9.0	13.0	10.0	500	46KF2330(1)P0(2)	R46KF2330(1)P0(2)
0.047	4.0	9.0	13.0	10.0	500	46KF2470(1)P0(2)	R46KF2470(1)P0(2)
0.068	5.0	11.0	13.0	10.0	500	46KF2680(1)P0(2)	R46KF2680(1)P0(2)
0.10	5.0	11.0	13.0	10.0	500	46KF3100(1)P1(3)	R46KF3100(1)P1(3)
0.10	6.0	12.0	13.0	10.0	500	46KF3100(1)P0(2)	R46KF3100(1)P0(2)
0.15	6.0	12.0	13.0	10.0	500	46KF3150(1)P0(3)	R46KF3150(1)P0(3)
0.15	5.0	11.0	18.0	15.0	400	46KI3150(1)P0(2)	R46KI3150(1)P0(2)
0.22	6.0	12.0	18.0	15.0	400	46KI3220(1)P0(2)	R46KI3220(1)P0(2)
0.33	7.5	13.5	18.0	15.0	400	46KI3330(1)P0(2)	R46KI3330(1)P0(2)
0.33	9.0	12.5	18.0	15.0	400	46KI3330(1)P1(2)	R46KI3330(1)P1(2)
0.33	6.0	17.5	18.0	15.0	400	46KI3330(1)P2(2)	R46KI3330(1)P2(2)
0.47	8.5	14.5	18.0	15.0	400	46KI3470(1)P0(2)	R46KI3470(1)P0(2)
0.47	9.0	12.5	18.0	15.0	400	46KI3470(1)P1(3)	R46KI3470(1)P1(3)
0.47	6.0	17.5	18.0	15.0	400	46KI3470(1)P2(3)	R46KI3470(1)P2(3)
0.47	7.5	18.5	18.0	15.0	400	46KI3470(1)P3(2)	R46KI3470(1)P3(2)
0.68	10.0	16.0	18.0	15.0	400	46KI3680(1)P1(2)	R46KI3680(1)P1(2)
0.68	11.0	19.0	18.0	15.0	400	46KI3680(1)P0(2)	R46KI3680(1)P0(2)
0.82	11.0	19.0	18.0	15.0	400	46KI3820(1)P0(3)	R46KI3820(1)P0(3)
0.47	6.0	15.0	26.5	22.5	200	46KN3470(1)P1(2)	R46KN3470(1)P1(2)
0.56	6.0	15.0	26.5	22.5	200	46KN3560(1)P1(3)	R46KN3560(1)P1(3)
0.56	7.0	16.0	26.5	22.5	200	46KN3560(1)P0(2)	R46KN3560(1)P0(2)
0.68	7.0	16.0	26.5	22.5	200	46KN3680(1)P0(2)	R46KN3680(1)P0(2)
1.0	8.5	17.0	26.5	22.5	200	46KN4100(1)P1(3)	R46KN4100(1)P1(3)
1.0	10.0	18.5	26.5	22.5	200	46KN4100(1)P0(2)	R46KN4100(1)P0(2)
1.5	10.0	18.5	26.5	22.5	200	46KN4150(1)P1(3)	R46KN4150(1)P1(3)
1.5	11.0	20.0	26.5	22.5	200	46KN4150(1)P0(2)	R46KN4150(1)P0(2)
2.2	13.0	22.0	26.5	22.5	200	46KN4220(1)P0(3)	R46KN4220(1)P0(3)
1.0	9.0	17.0	32.0	27.5	150	46KR4100(1)P0(2)	R46KR4100(1)P0(2)
1.5	11.0	20.0	32.0	27.5	150	46KR4150(1)P0(2)	R46KR4150(1)P0(2)
2.2	13.0	22.0	32.0	27.5	150	46KR4220(1)P0(2)	R46KR4220(1)P0(2)
3.3	14.0	28.0	32.0	27.5	150	46KR4330(1)P0(2)	R46KR4330(1)P0(2)
4.7	14.0	28.0	32.0	27.5	150	46KR4470(1)P1(3)	R46KR4470(1)P1(3)
4.7	18.0	33.0	32.0	27.5	150	46KR4470(1)P0(2)	R46KR4470(1)P0(2)
6.8	22.0	37.0	32.0	27.5	150	46KR4680(1)P0(2)	R46KR4680(1)P0(2)
2.2	11.0	22.0	41.5	37.5	100	46KW4220(1)P0(2)	R46KW4220(1)P0(2)
3.3	13.0	24.0	41.5	37.5	100	46KW4330(1)P0(2)	R46KW4330(1)P0(2)
4.7	16.0	28.5	41.5	37.5	100	46KW4470(1)P0(2)	R46KW4470(1)P0(2)
6.8	19.0	32.0	41.5	37.5	100	46KW4680(1)P0(2)	R46KW4680(1)P0(2)
10.0	20.0	40.0	41.5	37.5	100	46KW5100(1)P0(2)	R46KW5100(1)P0(2)
Capacitance Value (µF)	T (mm)	H (mm)	L (mm)	Lead Spacing (S)	dV/dt (V/μs)	KEMET Part Number	Legacy Part Number

<sup>(1)</sup> Insert lead and packaging code. See Ordering Options Table for available options.

<sup>(2)</sup>  $M = \pm 20\%$ ,  $K = \pm 10\%$ 

<sup>(3)</sup>  $M = \pm 20\%$  (only available tolerance).



### **Soldering Process**

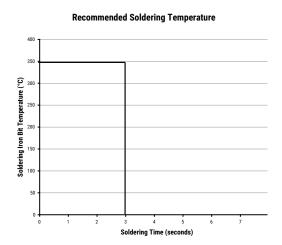
The implementation of the RoHS directive has resulted in the selection of SnAuCu (SAC) alloys or SnCu alloys as primary solder material. This has increased the liquidus temperature from  $183^{\circ}$ C for SnPb eutectic alloys to  $217 - 221^{\circ}$ C for the new alloys. As a result, the heat stress to the components, even in wave soldering, has increased considerably due to higher preheat and wave temperatures. Polypropylene capacitors are especially sensitive to heat (the melting point of polypropylene is  $160 - 170^{\circ}$ C). Wave soldering can be destructive, especially for mechanically small polypropylene capacitors (with lead spacing of 5 - 15 mm). Great care must be taken during soldering. The recommended solder profiles from KEMET should be used. Consult KEMET with any questions. In general, the wave soldering curve from IEC Publication 61760-1 Edition 2 serves as a solid quideline for successful soldering. See Figure 1.

Reflow soldering is not recommended for through-hole film capacitors. Exposing capacitors to a soldering profile in excess of the above-recommended limits may result to degradation of or permanent damage to the capacitors.

Do not place the polypropylene capacitor through an adhesive curing oven to cure resin for surface mount components. Insert through-hole parts after curing surface mount parts. Consult KEMET to discuss the actual temperature profile in the oven, if through-hole components must pass through the adhesive curing process. A maximum two soldering cycles is recommended. Allow time for the capacitor surface temperature to return to normal temperature before performing the second soldering cycle.

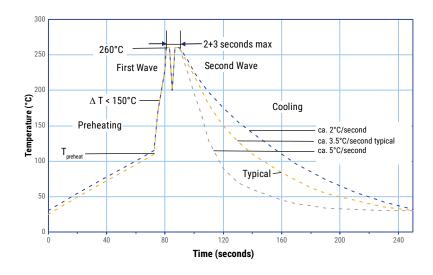
#### **Manual Soldering Recommendations**

Following is the recommendation for manual soldering with a soldering iron.



The soldering iron tip temperature should be set at 350°C (+10°C maximum), with the soldering duration not to exceed more than 3 seconds.

#### **Wave Soldering Recommendations**





### **Soldering Process cont.**

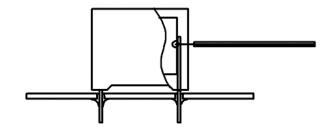
#### **Wave Soldering Recommendations cont.**

1. The table indicates the maximum set-up temperature of the soldering process.

Dielectric Film Material		mum heat erature	Maximum Peak Soldering Temperature		
	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	Capacitor Pitch ≤ 15 mm	Capacitor Pitch > 15 mm	
Polyester	130°C	130°C	270°C	270°C	
Polypropylene	110°C	130°C	260°C	270°C	
Paper	130°C	140°C	270°C	270°C	
Polyphenylene Sulphide	150°C	160°C	270°C	270°C	

2. The maximum temperature measured inside the capacitor: set the temperature so that the maximum temperature inside the element is below the limit.

Dielectric Film Material	Maximum Temperature Measured Inside the Element
Polyester	160°C
Polypropylene	110°C
Paper	160°C
Polyphenylene Sulphide	160°C



Temperature monitored inside the capacitor.

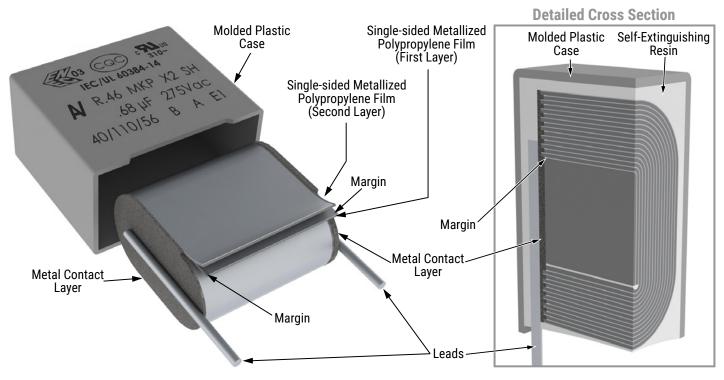
#### **Selective Soldering Recommendations**

Selective dip soldering is a variation of reflow soldering. In this method, the printed circuit board with through-hole components to be soldered is preheated and transported over the solder bath as it is in normal flow soldering, without touching the solder. When the board is over the bath, it is stopped. Pre-designed solder pots are lifted from the bath with molten solder, only at the places of the selected components, and pressed against the lower surface of the board to solder the components.

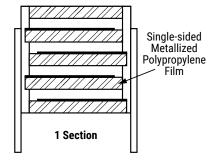
The temperature profile for selective soldering is similar to the double wave flow soldering outlined in this document. **However, instead of two baths, there is only one with a time from 3 – 10 seconds.** In selective soldering, the risk of overheating is greater than in double wave flow soldering, and great care must be taken so that the parts do not overheat.



#### Construction



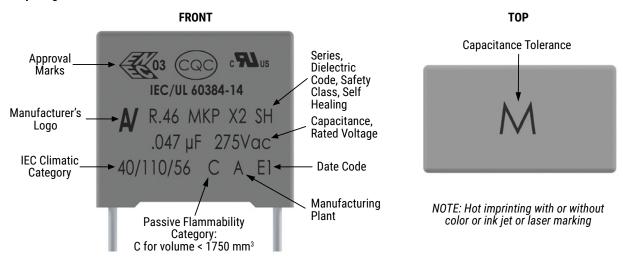
### **Winding Scheme**



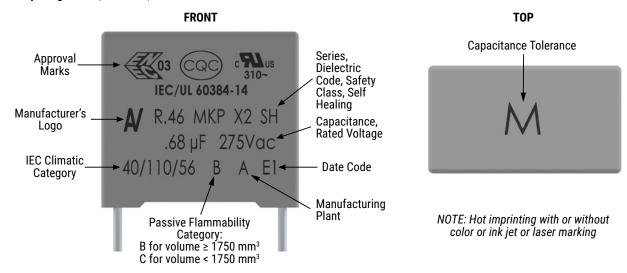


### **Marking**

#### Lead Spacing 10 mm



#### Lead Spacing 15 mm, 22.5 mm, and 27.5 mm



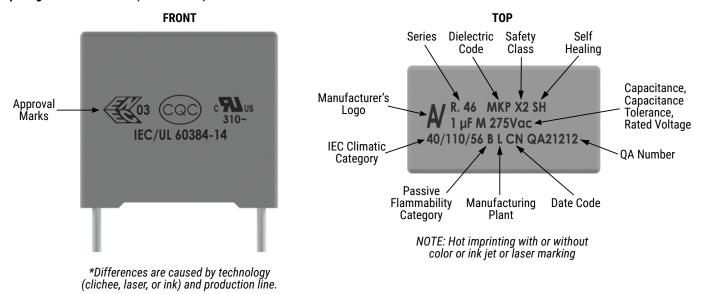
Slight change in the layout can be possible but this does not affect the content of the information of the current marking.

This change will be achieved without impact to product form, fit or function, as the products are equivalent with respect to physical, mechanical, quality and reliability characteristics.



### Marking cont.

#### Lead Spacing 22.5 and 27.5 mm (alternatives\*) and 37.5 mm



Slight change in the layout can be possible but this does not affect the content of the information of the current marking.

This change will be achieved without impact to product form, fit or function, as the products are equivalent with respect to physical, mechanical, quality and reliability characteristics.

	Manufacturing Date Code (IEC 60062)											
Year Code Year Code Month Code Month C												
2020	М	2027	V	2034	E	January	1	July	7			
2021	N	2028	W	2035	F	February	2	August	8			
2022	Р	2029	Χ	2036	Н	March	3	September	9			
2023	R	2030	Α	2037	J	April	4	October	0			
2024	S	2031	В	2038	K	May	5	November	N			
2025	T	2032	С	2039	L	June	6	December	D			
2026	U	2033	D	2040	М							



## **Packaging Quantities**

Lead Spacing (mm)	Thickness (mm)	Height (mm)	Length (mm)	Bulk Short Leads		ılk Leads	Standard Reel ø 355 mm	Large Reel ø 500 mm	Ammo Taped
Lead and Packaging Code:			00 - JA - JB JE - JH	JM	40 - 50	GY	СК	DQ	
	4	9	13	2,000	2,200	1,800	750	1,500	1,000
10	5	11	13	1,300	2,000	1,500	600	1,250	800
	6	12	13	1,000	1,800	1,200	500	1,000	680
	5	11	18	2,000	1,250	1,000	600	1,250	800
	6	12	18	1,750	1,000	900	500	1,000	680
	6	17.5	18	1,000	800	700	500	1,000	680
	7.5	13.5	18	1,000	650	700	350	800	500
15	7.5	18.5	18	900	650	500	-	800	500
	8.5	14.5	18	1,000	700	500	300	700	440
	9	12.5	18	1,000	550	520	270	650	410
	10	16	18	750	400	500	270	600	380
	11	19	18	450	350	350	-	500	340
	_	·				·	· · · · · · · · · · · · · · · · · · ·		
	6	15	26.5	805	450	500	-	700	464
	7	16	26.5	700	450	500	-	550	380
22.5	8.5	17	26.5	468	350	300	-	450	280
	10	18.5	26.5	396	350	300	-	350	235
	11	20	26.5	360	200	250	-	350	217
	13	22	26.5	300	150	200	-	300	-
	9	17	32	816	408	408	-	450	-
	11	20	32	560	336	336	-	350	-
07.5	13	22	32	480	288	288	-	300	-
27.5	14	28	32	352	176	176	-	-	-
	18	33	32	256	128	128	-	-	-
	22	37	32	168	112	112	-	-	-
	11	22	41.5	420	252	252	_	_	_
	13	24	41.5	360	216	252		-	
37.5	16	28.5	41.5	216	108	108	-	-	-
37.3	19	32	41.5	192	96	96	-	-	-
	20	40	41.5	192	84	84	-	-	-
	20	40	41.3	120	04	04	_	-	

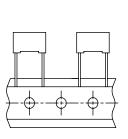


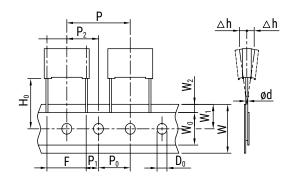
## Lead Taping & Packaging (IEC 60286-2)

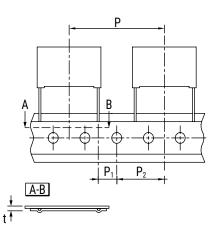
Figure 1 Lead Spacing 10 mm

Figure 2 Lead Spacing 15 mm

Figure 3 Lead Spacing 22.5 – 27.5 mm







## **Taping Specification**

			Dim	ensions (r	nm)	
Description	Symbol					
Description	Cymbol	10	15	22.5	27.5	Tol.
		Fig. 1	Fig. 2	Fig. 3	Fig. 3	
Lead wire diameter	d	0.6	0.6-0.8	0.8	0.8	±0.05
Taping lead space	Р	25.4	25.4	38.1	38.1	±1
Feed hole lead space *	$P_0$	12.7	12.7	12.7	12.7	±0.2 **
Centering of the lead wire	P <sub>1</sub>	7.7	5.2	7.8	5.3	±0.7
Centering of the body	$P_2$	12.7	12.7	19.05	19.05	±1.3
Lead spacing (pitch) ***	F	10	15	22.5	27.5	+0.6/-0.1
Component alignment	Δh	0	0	0	0	±2
Height of component from tape center	H <sub>0</sub> ****	18.5	18.5	18.5	18.5	±0.5
Carrier tape width	W	18	18	18	18	+1/-0.5
Hold down tape width	$W_{0}$	9	10	10	10	Minimum
Hole position	W <sub>1</sub>	9	9	9	9	±0.5
Hold down tape position	W <sub>2</sub>	3	3	3	3	Maximum
Feed hole diameter	D <sub>0</sub>	4	4	4	4	±0.2
Total tape thickness	t	0.7	0.7	0.7	0.7	±0.2

<sup>\* 15</sup> mm also available

<sup>\*\*</sup> Maximum of 1 mm on 20 lead spaces

<sup>\*\*\*</sup> Pitches 15 mm and 10 mm taped to 7.5 mm (crimped leads) available upon request

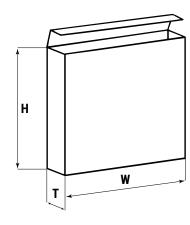
<sup>\*\*\*\*</sup>  $H_0$  = 16.5 mm is available upon request



## Lead Taping & Packaging (IEC 60286-2) cont.

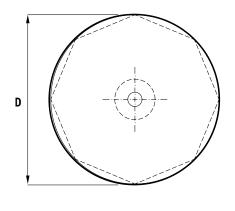
## **Ammo Specifications**

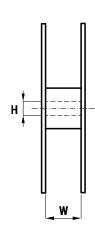
Dimensions (mm)				
Н	W	Т		
360	340	59		



## **Reel Specifications**

Reel Size	Dimensions (mm)		
Reel Size	D	Н	W
Standard	355	30	FF Mavimum
Large	500	25	55 Maximum







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